

Title (en)

METHODS OF BONDING MATERIALS, ESPECIALLY MATERIALS USED IN ABSORBENT ARTICLES

Title (de)

VERFAHREN ZUM VERBINDEN VON WERKSTOFFEN, INSBESONDERE ZUR VERWENDUNG IN ABSORBIERENDE ARTIKEL

Title (fr)

PROCEDES DE LIAISON DE MATERIAUX, EN PARTICULIER DE MATERIAUX UTILISES DANS DES ARTICLES ABSORBANTS

Publication

EP 1034067 A2 20000913 (EN)

Application

EP 98960490 A 19981125

Priority

- US 9825222 W 19981125
- US 97997997 A 19971126
- US 97998097 A 19971126
- US 3135298 A 19980226

Abstract (en)

[origin: WO9926769A2] Methods of bonding materials used in the manufacture of articles, including, but not limited to, absorbent articles such as sanitary napkins, pantliners, tampons, absorbent interlabial devices, diapers, incontinence devices, wipes, and the like are disclosed. There are numerous aspects of the disclosed methods. In one aspect, the method involves bonding through incompatible materials during the process of making a composite structure comprising several materials. In another aspect, improvements are made that allow the method to be used to bond through relatively thick materials (e.g., materials having a thickness of greater than or equal to about 4 mm). In another aspect, the methods are provided with the ability to create a virtually unlimited number of bonding patterns in the materials to be bonded. In still another aspect, the methods of bonding utilize a compression step to improve bond formation. In still another aspect, methods of bonding that utilize a step of slitting a material through which the bonds are made are disclosed.

IPC 1-7

B27N 1/00

IPC 8 full level

A61F 5/44 (2006.01); **A61F 13/15** (2006.01); **A61F 13/472** (2006.01); **A61F 13/49** (2006.01); **A61F 13/53** (2006.01)

CPC (source: EP KR)

A61F 13/15699 (2013.01 - EP); **B29C 65/02** (2013.01 - EP); **B29C 65/18** (2013.01 - EP); **B29C 65/7441** (2013.01 - EP); **B29C 66/1122** (2013.01 - EP); **B29C 66/21** (2013.01 - EP); **B29C 66/4322** (2013.01 - EP); **B29C 66/4332** (2013.01 - EP); **B29C 66/436** (2013.01 - EP); **B29C 66/727** (2013.01 - EP); **B29C 66/7394** (2013.01 - EP); **B29C 66/81429** (2013.01 - EP); **B29C 66/81433** (2013.01 - EP); **B29C 66/83411** (2013.01 - EP); **B29C 66/83511** (2013.01 - EP); **B32B 37/28** (2013.01 - KR); **B29C 65/08** (2013.01 - EP); **B29C 66/71** (2013.01 - EP); **B29C 66/729** (2013.01 - EP); **B29C 66/7294** (2013.01 - EP); **B29C 66/81264** (2013.01 - EP); **B29C 66/83413** (2013.01 - EP); **B29K 2995/007** (2013.01 - EP); **B29L 2031/4878** (2013.01 - EP)

Citation (search report)

See references of WO 9926769A2

Designated contracting state (EPC)

AT BE CH CY DE DK ES FI FR GB GR IE IT LI LU NL PT SE

DOCDB simple family (publication)

WO 9926769 A2 19990603; **WO 9926769 A3 19990902**; AU 1607499 A 19990615; AU 749938 B2 20020704; BR 9815330 A 20020226; CA 2311393 A1 19990603; CA 2311393 C 20041019; CN 1209083 C 20050706; CN 1283977 A 20010214; CN 1297243 C 20070131; CN 1548019 A 20041124; EP 1034067 A2 20000913; JP 2001523537 A 20011127; KR 100397748 B1 20030913; KR 100439385 B1 20040709; KR 20010032395 A 20010416; KR 20030033080 A 20030426

DOCDB simple family (application)

US 9825222 W 19981125; AU 1607499 A 19981125; BR 9815330 A 19981125; CA 2311393 A 19981125; CN 200410059731 A 19981125; CN 98813318 A 19981125; EP 98960490 A 19981125; JP 2000521953 A 19981125; KR 20007005635 A 20000524; KR 20037004198 A 20030322